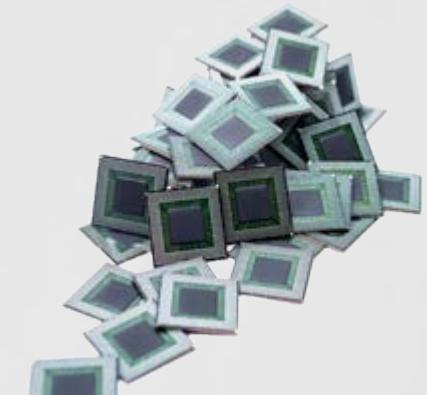




nec



SPACE PROJECTS COLLABORATION PLATFORM SUPPLY CHAIN MANAGEMENT

NICO BEYLEMANS

MARCH 2019

OVERVIEW

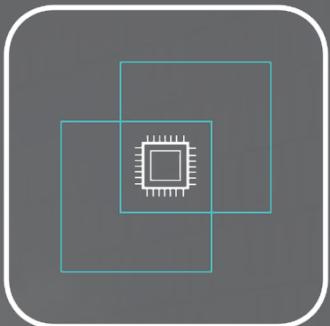
- INTRODUCTION
- PORTFOLIO
- TODAY AND THE FUTURE

TAKE HOME

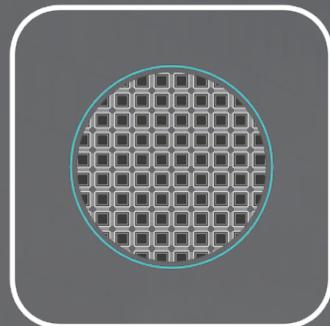
- Different project options
- Opportunities and challenges
- Our contact details

4000 highly skilled researchers and employees
investment of 2B€ on advanced equipment
2,099 peer-reviewed papers in 2018
181 patents filed in 2018
Currently developing **2nm CMOS**

MICROCHIP TECHNOLOGY ENABLES



INTEGRATION



MASS PRODUCTION



LOW COST

50 BILLION CONNECTED DEVICES BY 2020

IOT
SUPER BRAIN
OF THE WORLD



IMEC. IC-LINK

ASIC DESIGN, SERVICES AND PRODUCTION

> 1000 COMPANIES AND ACADEMIC CUSTOMERS

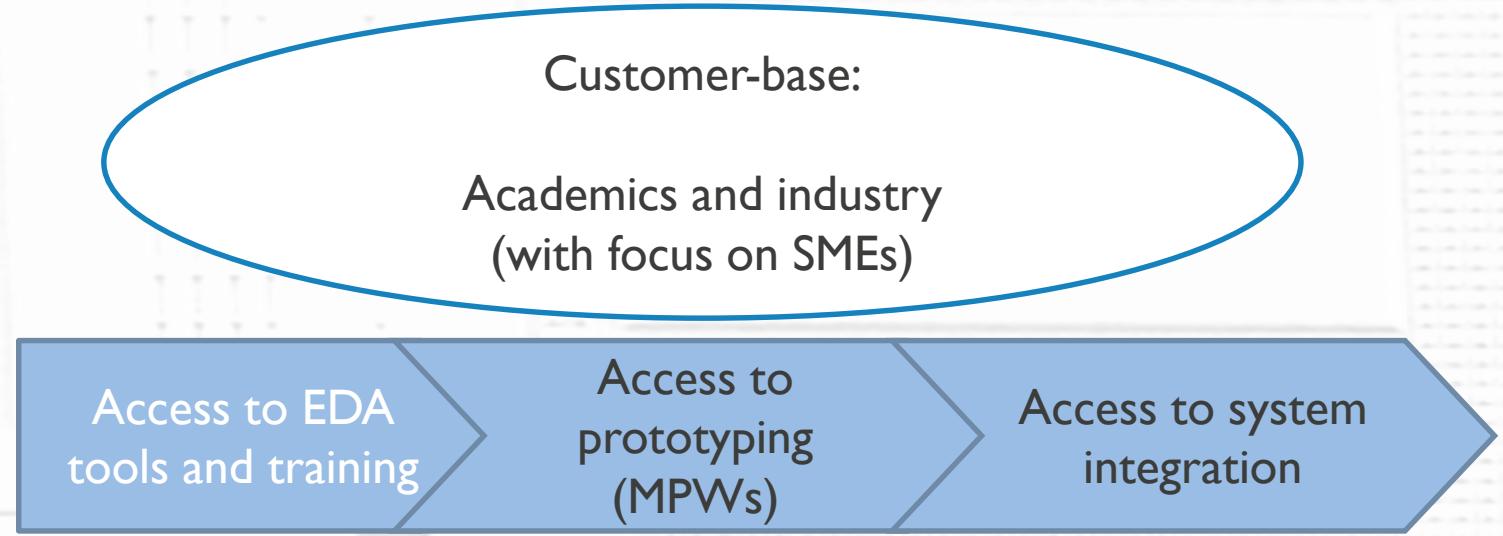
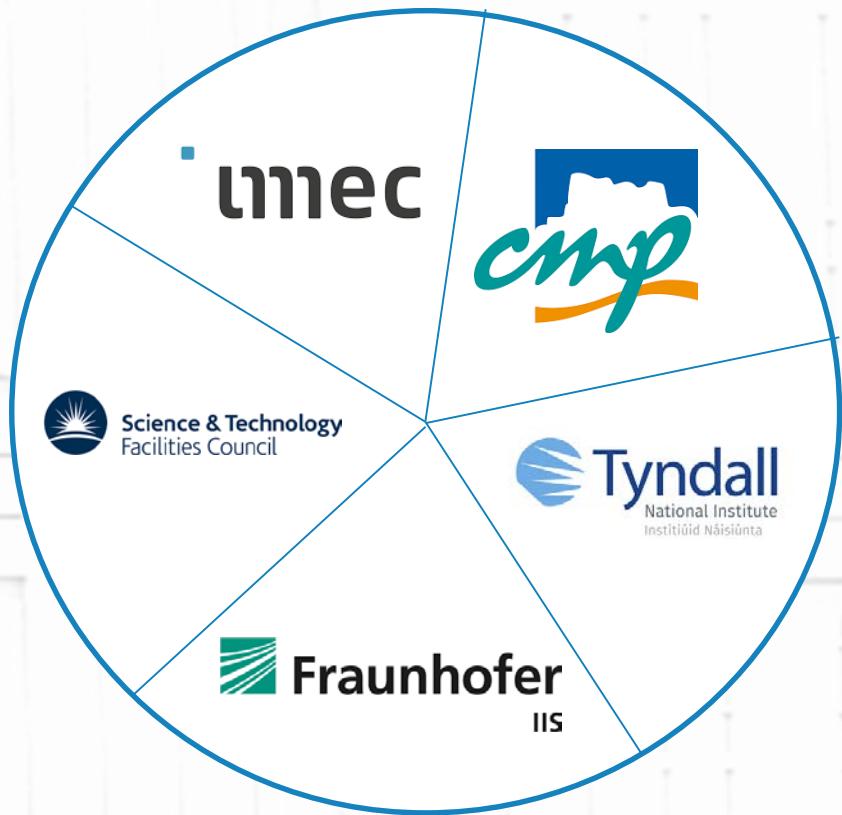
EUROPRACTICE SERVICE

DARE LIBRARY DEVELOPMENT

ASIC PRODUCTION

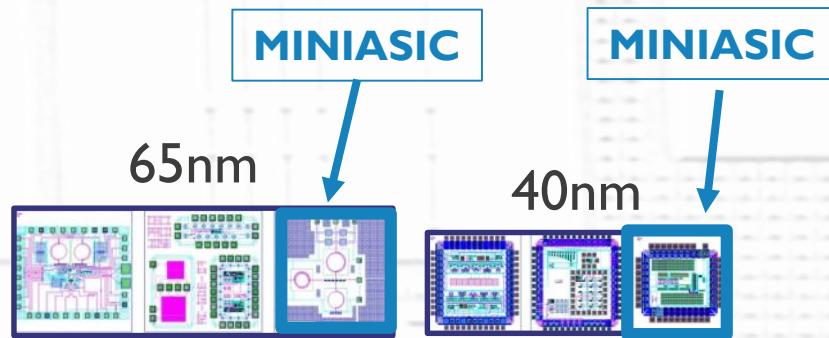
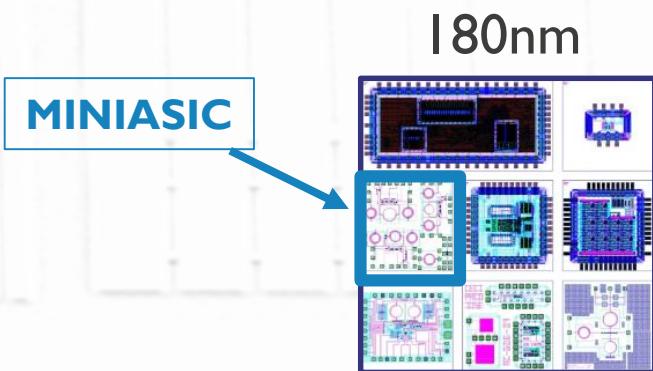


EUROPRACTICE



Technology-base:

Commercial vendors / foundries and
EU Pilot Lines

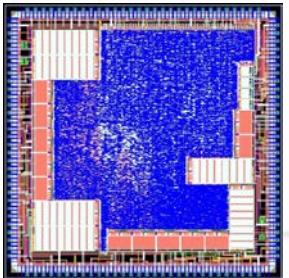


DARE PLATFORMS

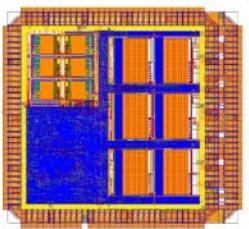
DARE = DESIGN AGAINST RADIATION EFFECTS

- Cooperation with ESA & CERN
- Radiation-hardened-by-design libraries in standard commercial technology
- Lot validation up to Flight Module
- Radiation-hardened-by-design libraries in standard commercial technologies
 - DARE180U UMC MM/RF 180nm
 - DARE180X XFAB XH018
 - DARE90U UMC MM/RF 90nm
 - DARE350ON OnSemi I3T80
 - DARE65T TSMC 65nm LP
 - DARE22G GF 22nm FDSOI
 - (DARE16T) TSMC16FFC
- <https://dare.imec-int.com/en/home>
- <https://www.imec-int.com/en/what-we-offer/ic-link/radiation-hardened-cmos-technology>

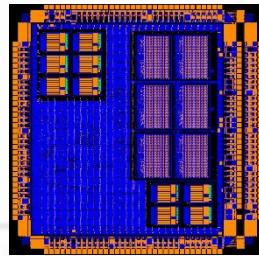
APPLICATION CHIPS OVERVIEW



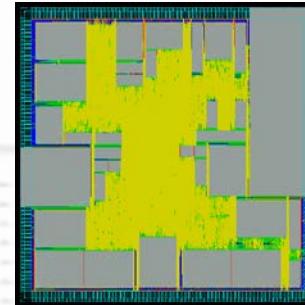
KNUT



LARS



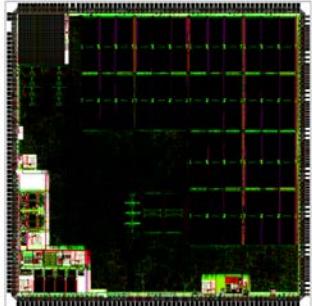
LARS2



DPC



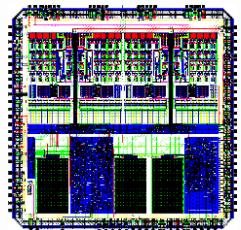
Cobham Gaisler AB



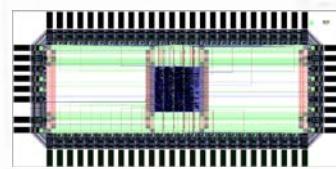
GR716
microcontroller



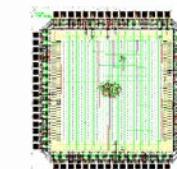
Netherlands Institute for Space Research



FAIR



Digital companion
to I3T80 chip



Relco

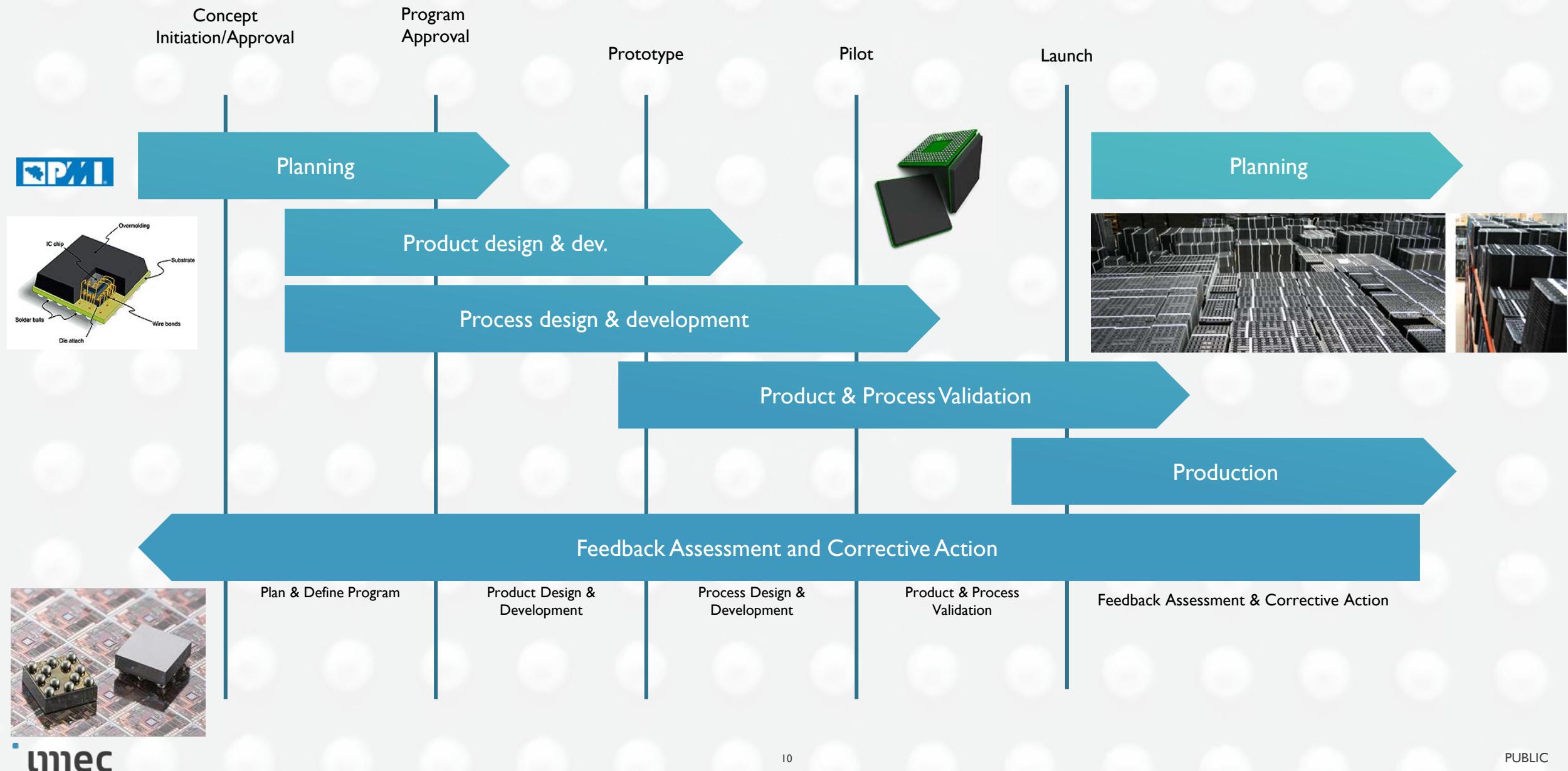
ASIC PRODUCTION

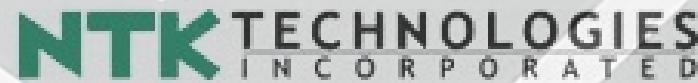
SUPPLY CHAIN DELIVERABLES



A trusted **one-stop-shop** for innovative products and prototypes

AUTOMOTIVE PROJECT FLOW COMPLEMENTARY TO SPACE





THE FUTURE FORECAST AND CHALLENGES

Customer requirements

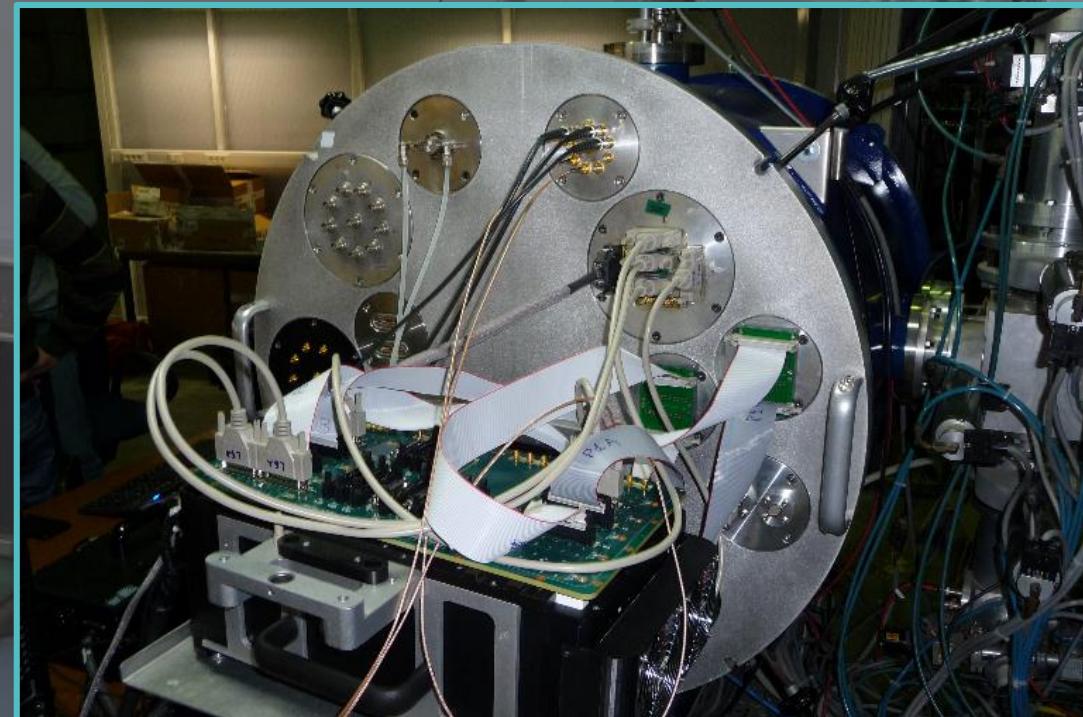
Time to market

Budget

New space / automotive

Changing standards

- Qualification of Dies
- High pin count packages
- Plastic packages



THANK YOU

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Nico.Beylemans@imec.be

IMEC'S MISSION

- Imec is the world-leading R&D and innovation hub in **nanoelectronics** and digital technology.
- As a **trusted partner** for companies, start-ups and academia we bring together brilliant minds from all over the world in a creative and stimulating environment.
- By leveraging our world-class infrastructure and local and global ecosystem of diverse expert partners across a multitude of industries, we accelerate progress towards a **connected, sustainable future**.

